

## Appendix-I

### Properties of intrinsic semiconductors at 300 K

Properties	Material						
	Ge	Si	GaAs	GaP	InP	InSb	ZnS
Energy band gap, $E_g$ (eV)	0.67	1.11	1.43	2.76	1.35	0.18	3.6
Electron Mobility, $\mu_n$ (cm <sup>2</sup> /V.s)	3900	1350	8500	300	4000	10 <sup>5</sup>	110
Hole mobility, $\mu_p$ (cm <sup>2</sup> /V.s)	1900	480	400	150	100	1700	-
Intrinsic carrier concentration $n_i$ (cm <sup>-3</sup> ) $E_f$	2.4 x 10 <sup>13</sup>	1.5 x 10 <sup>10</sup>	1.79 x 10 <sup>6</sup>		1.2 x 10 <sup>8</sup>		
Resistivity $\rho$ ( $\Omega$ cm)	43	2.5 x 10 <sup>5</sup>	4x 10 <sup>8</sup>	1	8 x 10 <sup>-3</sup>	0.06	10 <sup>10</sup>
Transition (Type of energy band structure) direct/indirect	i	i	d	i	d	d	d
Lattice constant $a$ ( $\text{Å}$ )	5.66	5.43	5.65	5.45	5.87	6.48	5.409
Density (g/cm <sup>3</sup> )	5.32	2.33	5.31	4.13	4.79	5.78	4.09
Atomic / Molecular weight (g/mole)	72.6	28.09	144.63	100.694	145.794	236.57	97.44
Melting point ( $^{\circ}$ C)	936	1415	1238	1467	1070	525	1650
Dielectric constant Relative permittivity, $\epsilon_r$	16	11.8	13.2	11.1	12.4	17.7	8.9
Electron affinity, $\psi_s$ (V)	4.0	4.05	4.07		4.38		
Density of states in conduction band, $N_C$ (cm <sup>-3</sup> )	1.04 x 10 <sup>19</sup>	2.8 x 10 <sup>19</sup>	4.7 x 10 <sup>17</sup>				
Density of states in valence band, $N_V$ (cm <sup>-3</sup> )	6 x 10 <sup>18</sup>	1.02 x 10 <sup>19</sup>	7 x 10 <sup>18</sup>				
Critical field or Breakdown field (V/cm)	10 <sup>5</sup>	3 x 10 <sup>5</sup>	4x 10 <sup>5</sup>				
Crystal structure Diamond / Zinc blende / Wurtzite	D	D	Z	Z	Z	Z	Z,W

## Appendix-II

### Properties of SiO<sub>2</sub> and Si<sub>3</sub>N<sub>4</sub>

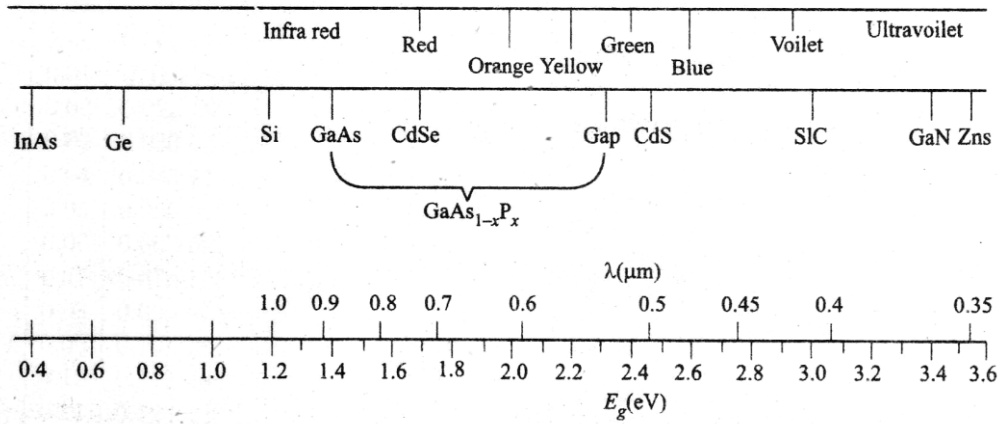
Property	SiO <sub>2</sub>	Si <sub>3</sub> N <sub>4</sub>
Structure	amorphous	amorphous
Density (g/cm <sup>3</sup> )	2.2	3.1
Dielectric constant $\epsilon_r$	3.9	7.5
Dielectric strength (V/cm)	10 <sup>7</sup>	107
Energy gap (eV)	9	5
Resistivity at 25°C ( $\Omega$ cm)	$\sim 10^{15}$	$\sim 10^{14}$
Refractive index	1.46	3.1

## Appendix-III

### Work functions and Richardson Constants

Metal	$\phi_m$ (V)	$R^*$ (A/cm <sup>2</sup> /K <sup>2</sup> )
Al	4.2	-
Au	4.7	-
Pt	5.4	32
Cu	4.4	65
W	4.5	60

**Appendix-IV**  
**Band gaps of common semiconductors related to the optical spectrum**



**Appendix-V**  
**Physical Constants**

Name	Symbol	Value
Avogadro number	N	$6.023 \times 10^{23}/\text{mole}$
Boltzmann constant	k	$1.381 \times 10^{-23} \text{ J/K}$
Electronic charge	q	$1.602 \times 10^{-19} \text{ C}$
Electron rest mass	$m_0$	$9.109 \times 10^{-34} \text{ g}$
Permittivity of free space	$\epsilon_0$	$8.854 \times 10^{-14} \text{ F/cm}$
Planck's constant	h	$6.626 \times 10^{-34} \text{ J-s}$
Thermal voltage at 300 K	$V_T$	0.0259 V
Velocity of light in vacuum	c	$2.998 \times 10^{10} \text{ cm/s}$
Electron volt	eV	1 eV = $1.602 \times 10^{-19} \text{ J}$
Amstrong ( $A^0$ )		1 $A^0 = 10^{-8} \text{ cm} = 10^{-4} \mu\text{m}$

**Appendix-VI**  
**Hyperbolic functions**

$$\sinh x = \frac{e^x - e^{-x}}{2}$$

$$\cosh x = \frac{e^x + e^{-x}}{2}$$

$$\tanh x = \frac{e^x - e^{-x}}{e^x + e^{-x}}$$

$$\frac{d}{dx}(\sinh x) = \cosh x$$

$$\frac{d}{dx}(\cosh x) = \sinh x$$

$$\frac{d}{dx}(\tanh x) = \frac{2}{\cosh^2 x}$$

$$\tanh x = x - \frac{x^3}{3} + \dots$$

$$\cot h x = \frac{1}{x} + \frac{x}{3} - \frac{x^3}{45} + \dots$$

$$\sec h x = 1 - \frac{x^2}{2} + \frac{5x^4}{24} - \dots$$

$$\operatorname{cosec} h x = \frac{1}{x} - \frac{x}{6} + \frac{7x^3}{360} - \dots$$

**Appendix - VII**  
**Unit Prefixes**

Multiple	Prefix	Symbol	Multiple	Prefix	Symbol
$10^{12}$	tera	T	$10^{-1}$	deci	d
$10^9$	giga	G	$10^{-2}$	centi	c
$10^6$	mega	M	$10^{-3}$	milli	m
$10^3$	Kilo	k	$10^{-6}$	micro	$\mu$
$10^2$	hecto	h	$10^{-9}$	nano	n
10	deca	da	$10^{-12}$	pico	P

### Appendix-VIII

#### Table of Error Function erf (u)

<b>u</b>	<b>erf(u)</b>	<b>u</b>	<b>erf(u)</b>	<b>u</b>	<b>erf(u)</b>	<b>u</b>	<b>erf(u)</b>
0.00	0.000 000	0.33	0.359 279	0.65	0.642 029	0.97	0.829 870
0.01	0.011 283	0.34	0.369 365	0.66	0.649 377	0.98	0.834 232
0.02	0.022 565	0.35	0.379 382	0.67	0.656 628	0.99	0.838 508
0.03	0.033 941	0.36	0.389 330	-0.68	0.663 792	1.00	0.842 701.
0.04	0.045 111	0.37	0.399 206	0.69	0.670 840	1.01	0.846 810
0.05	0.056 372	0.38	0.409 009	0.70	0.677 801	1.02	0.850 838
0.06	0.067622	0.39	0.418 739	0.71	0.684666	1.03	0.854 784
0.07	0.078 858	0.40	0.428 392	0.72	0.691 433	1.04	0.858 650
0.08	0.090 078	0.41	0.437 969	0.73	0.698 104	1.05	0.862 436
0.09	0.101 281	0.42	0.447 969	0.74	0.704 678	1.06	0.806 144
0.10	0.112 463	0.43	0.456 887	0.75	0.711 156	1.07	0.869 773
0.11	0.123 623	0.44	0.466 225	0.76	0.717 537	1.08	0.873 326
0.13	0.145 867	0.45	0.475 482	0.77	0.723 822	1.09	0.870 803
0.14	0.156 947	0.46	0.484655	0.78	0.730 010	1.10	0.880 205
0.15	0.167 996	0.47	0.493 745	0.79	0.736 103	1.11	0.883 533
0.16	0.179 012	0.48	0.502 750	0.80	0.742 101	1.12	0.886 788
0.17	0.189 992	0.49	0.511 668	0.81	0.748 003	1.13	0.889 971
0.18	0.200 936	0.50	0.520 500	0.82	0.753 811	1.14	0.893 082
0.19	0.211 840	0.51	0.529 244	0.83	0.759 524	1.15	0.896 124
0.20	0.222 703	0.52	0.537 899	0.84	0.765 143	1.16	0.899 096
0.21	0.233 522	0.53	0.546 464	0.85	0.770 668	1.17	0.902 000
0.22	0.244 296	0.54	0.554 939	0.86	0.776 110	1.18	0.904 837
0.23	0.255 023	0.55	0.563 323	0.87	0.781 440	1.20	0.910 314
0.24	0.265 700	0.56	0.571 616	0.88	0.786 687	1.21	0.912 956
0.25	0.276 326	0.57	0.579 816	0.89	0.791 843	1.22	0.815 534
0.26	0.286 900	0.58	0.597 923	0.90	0.796 908	1.23	0.918 050
0.27	0.297 418	0.59	0.595 936	0.91	0.801 883	1.24	0.920 505
0.28	0.307 880	0.60	0.603 856	0.92	0.806 768	1.25	0.922 900
0.29	0.318 283	0.61.	0.611 681	0.93	0.811 564	1.26	0.925 236
0.30	0.328 627	0.62	0.619 411	0.94	0.816 271	1.27	0.927 514
0.31	0.338 908	0.63	0.627 046	0.95	0.820 991	1.28	0.929 734
0.32	0.349 126	0.64	0.634 586	0.96	0.825 424	1.29	0.931 899

u	erf(u)	u	erf(u)	u	erf(u)	u	erf(u)
1.30	0.934 008	1.71	0.984 407	2.12	0.997 284	2.53	0.999 654
1.31	0.936 063	1.72	0.985 003	2.13	0.997 407	2.54	0.999 672
1.32	0.938 065	1.73	0.985 578	2.14	0.997 525	2.55	0.999 689
1.33	0.940 015	1.74	0.986 135	2.15	0.997 639	2.56	0.999 706
1.34	0.941 914	1.75	0.986 672	2.16	0.997 747	2.57	0.999 722
1.35	0.943 762	1.76	0.987 190	2.17	0.997 851	2.58	0.999 736
1.36	0.945 561	1.77	0.987 691	2.18	0.997 951	2.59	0.999 751
1.37	0.947 312	1.78	0.988 174	2.19	0.998 046	2.60	0.999 764
1.38	0.949 016	1.79	0.988 641	2.20	0.998 137	2.61	0.999 777
1.39	0.950 673	1.80	0.989 091	2.21	0.998 224	2.62	0.999 789
1.40	0.952 285	1.81	0.989 525	2.22	0.998 308	2.63	0.999 800
1.41	0.953 852	1.82	0.989 943	2.23	0.998 388	2.64	0.999 811
1.42	0.955 376	1.83	0.990 347	2.24	0.998 464	2.65	0.999 822
1.43	0.956 857	1.84	0.990 736	2.25	0.998 537	2.66	0.999 831
1.44	0.958 297.	1.85	0.991 111	2.26	0.998 607	2.67	0.999 841
1.45	0.959 695	1.86	0.991 472	2.27	0.998 674	2.68	0.999 849
1.46	0.961 054	1.87	0.991 821	2.28	0.998 738	2.69	0.999 858
1.47	0.962 373	1.88	0.992 156	2.29	0.998 799	2.70	0.999 866
1.48	0.963 654	1.89	0.992 479	2.30	0.998 857	2.71	0.999 873
1.49	0.964 898	1.90	0.992 790	2.31	0.998 912	2.72	0.999 880
1.50	0.966 105	1.91	0.993 090	2.32	0.998 966	2.73	0.999 887
1.51	0.967 277	1.92	0.993 378	2.33	0.999 016	2.74	0.999 893
1.52	0.968 413	1.93	0.993 656	2.34	0.999 065	2.75	0.999 899
1.53	0.969 516	1.94	0.993 923	2.35	0.999 111	2.76	0.999905
1.54	0.970 586	1.95	0.994 179	2.36	0.999 155	2.77	0.999 910
1.55	0.971 623	1.96	0.994 426	2.37	0.999 197	2.78	0.999 916
1.56	0.972 628	1.97	0.994664	2.38	0.999 197	2.79	0.999 920
1.57	0.973 603	1.98	0.994 892	2.39	0.999 275	2.80	0.999 925
1.58	0.974 547	1.99	0.995 111	2.40	0.999 311	2.81	0.999 929
1.59	0.975 462	2.00	0.995 322	2.41	0.999 346	2.82	0.999 933
1.60	0.976 348	2.01	0.995 525	2.42	0.999 379	2.83	0.999 937
1.61	0.977 207	2.02	0.995 719	2.43	0.999 411	2.84	0.999 941
1.62	0.978 308	2.03	0.995906	2.44	0.999 441	2.85	0.999 944
1.63	0.978 843	2.04	0.996 086	2.45	0.999 469	2.86	0.999 948
1.64	0.979 622	2.05	0.996 258	2.46	0.999 497	2.87,	0.999 951
1.65	0.980 376	2.06	0.996 423	2.47	0.999 523	2.88	0.999 954
1.66	0.981 105	2.07	0.996 582	2.48	0.999 547	2.89	0.999 956
1.67	0.981 810	2.08	0.996734	2.49	0.999 571	2.90	0.999 959
1.68	0.982 493	2.09	0.996880	2.50	0.999 593	2.91	0.999 961
1.69	0.983 153	2.10	0.997 021	2.51	0.999 614	2.92	0.999 964
1.70	0.983 790	2.11	0.997 155	2.52	0.999 634	2.93	0.999 966

u	erf(u)	u	erf(u)	u	erf(u)
2.96	0.999 972	3.36	0.999 997 983	3.76	0.999 999 895
2.97	0.999 973	3.37	0.999 998 120	3.77	0.999 999 903
2.98	0.999 975	3.38	0.999 998 247	3.78	0.999 999 910
2.99	0.999 976	3.39	0.999 998 367	3.79	0.999 999 917
3.00	0.999 977 91	3.40	0.999 998 478	3.80	0.999 999 923
3.01	0.999 979 26	3.41	0.999 998 582	3.81	0.999 999 929
3.02	0.999 980 53	3.42	0.999 998 679	3.82	0.999 999 934
3.03	0.999 981 73	3.43	0.999 998 770	3.83	0.999 999 939
3.04	0.999 982 86	3.44	0.999 998 855	3.84	0.999 999 944
3.05	0.999 983 92	3.45	0.999 998 934	3.85	0.999 999 948
3.06	0.999 984 92	3.46	0.999 999 008	3.86	0.999 999 952
3.07	0.999 985 86	3.47	0.999 999 077	3.87	0.999 999 956
3.08	0.999 986 74	3.48	0.999 999 141	3.88	0.999 999 959
3.09	0.999 987 57	3.49	0.999 999 201	3.89	0.999 999 962
3.10	0.999 988 35	3.50	0.999 999 257	3.90	0.999 999 965
3.11	0.999 989 08	3.51	0.999 999 309	3.91	0.999 999 968
3.12	0.999 989 77	3.52	0.999 999 358	3.92	0.999 999 970
3.13	0.999 990 42	3.53	0.999 999 403	3.93	0.999 999 973
3.14	0.999 991 03	3.54	0.999 999 445	3.94	0.999 999 975
3.15	0.999 991 60	3.55	0.999 999 485	3.95	0.999 999 977
3.16	0.999 992 14	3.56	0.999 999 521	3.96	0.999 999 979
3.17	0.999 992 64	3.57	0.999 999 555	3.97	0.999 999 980
3.18	0.999 993 11	3.58	0.999 999 587	3.98	0.999 999 982
3.19	0.999 993 56	3.59	0.999 999 617	3.99	0.999 999 983
3.20	0.999 993 97	3.60	0.999 999 644		
3.21	0.999 994 36	3.61	0.999 999 670		
3.22	0.999 994 73	3.62	0.999 999 694		
3.23	0.999 995 07	3.63	0.999 999 716		
3.24	0.999 995 40	3.64	0.999 999 736		
3.25	0.999 995 70	3.65	0.999 999 756		
3.26	0.999 995 98	3.66	0.999 999 773		
3.27	0.999 996 24	3.67	0.999 999 790		
3.28	0.999 996 49	3.68	0.999 999 805		
3.29	0.999 996 72	3.69	0.999 999 820		
3.30	0.999 996 94	3.70	0.999 999 833		
3.31	0.999 997 15	3.71	0.999 999 845		
3.32	0.999 997 34	3.72	0.999 999 857		
3.33	0.999 997 51	3.73	0.999 999 867		
3.34	0.99999768	3.74	0.999 999 877		

## Appendix-IX

### List of Symbols

$a$	-	lattice constant, Half thickness of channel of JFET, MESFET channel thickness
$A$	-	area
$B$	-	magnetic flux density
$B, E, C$	-	base, emitter, collector of BJT
$c$	-	velocity of light
$C$	-	capacitance/unit area of MOSFET
$C_j$	-	depletion layer capacitance of p-n junction
$C_s$	-	storage (diffusion) capacitance of p-n junction
$D$	-	diffusion coefficient of impurities
$D_n, D_p$	-	diffusion coefficient of electrons, holes
$D, G, S$	-	drain, gate source of FET
$E$	-	electric field strength
$E$	-	energy
$E_A, E_D$	-	acceptor, donor energy levels
$E_C, E_V$	-	conduction band, valence band edge
$E_F$	-	equilibrium Fermi level
$E_{F_n}, E_{F_p}$	-	equilibrium Fermi level in n material, p material
$E_r, E_t$	-	recombination, trap energy level
$E_g$	-	Energy band gap
$E_i$	-	intrinsic energy level
$f(E)$	-	Fermi-Dirac distribution function
$F_n, F_p$	-	quasi Fermi level for electrons, holes
$f_T$	-	figure of merit
$f_\alpha, f_\beta$	-	alpha, beta cutoff frequency
$g, g_{op}$	-	EHP generation rate, optical generation rate
$g_m$	-	transconductance or mutual conductance
$G_o$	-	channel conductance of JFET, MESFET under equilibrium
$hkl$	-	Miller indices
$h$	-	Planck's constant
$\hbar$	-	Planck's constant divided by $2\pi$
$h\nu$	-	photon energy
$I$	-	current
$I_B, I_C, I_E$	-	BJT DC base, collector, emitter current
$I_{CBO}$	-	magnitude of collector base saturation current with emitter open
$I_{CEO}$	-	collector emitter saturation current with base open
$I_{CS}$	-	collector base saturation current with emitter shorted to base
$I_{ES}$	-	emitter base saturation current with collector shorted to base



$I, F$ (superscript)	-	inverse, forward mode of BJT
$I_S$	-	reverse saturation current in a p-n junction
$I_R$	-	recombination current in a p-n junction
$J$	-	current density
$k$	-	Boltzmann constant
$\mathbf{k}$	-	wave vector
$k_0$	-	segregation constant
$k_p$	-	MOSFET device parameter
$L_n$	-	diffusion length for electron
$L_p$	-	diffusion length for holes
$\bar{l}$	-	mean free path for carriers in random motion
$m, m^*$	-	mass, effective mass
$m_n^*, m_p^*$	-	effective mass of electrons, holes
$m_0$	-	rest mass of electron
$M$	-	avalanche multiplication factor
$n$	-	electron concentration
$n^+$	-	heavily doped n-type material
$n_i$	-	intrinsic concentration of electrons
$n_{n_0}, n_{p_0}$	-	equilibrium concentration of electrons in n-type, p-type material
$n_0$	-	equilibrium concentration of electrons
$N_A, N_D$	-	concentration of acceptors, donors
$N_C, N_V$	-	effective density of states at the edge of the conduction band, valence band
$p$	-	concentration of holes in valence band
$p^+$	-	heavily doped p-type material
$p_{n_0}, p_{p_0}$	-	equilibrium concentration of holes in n-type, p-type material
$p_0$	-	equilibrium hole concentration
$q$	-	magnitude of electron charge
$Q_D$	-	depletion layer charge of p-n junction, depletion region charge per unit area of MOS device
$Q_f$	-	oxide fixed charge/area
$Q_I$	-	implanted charge per unit area in MOSFET
$Q_{ox}$	-	MOS oxide charge per unit area
$Q_m$	-	mobile ionic charge/area
$Q_s$	-	stored charge in p-n junction
$R_p$	-	projected range
$r$	-	recombination rate
$R$	-	resistance
$R_H$	-	Hall coefficient
$\bar{\tau}$	-	mean free time between scattering collisions
$t_{sd}$	-	storage delay time
$T$	-	temperature

$V_{CB}, V_{EB}$	-	voltage from collector to base, emitter to base in a BJT
$V_{DS}, V_{GS}$	-	voltage from drain to source, gate to source in an FET
$V$	-	Electrostatic Potential
$V_o$	-	contact potential
$V_p$	-	pinch-off voltage
$V_{PT}$	-	punch through voltage
$V_{th}$	-	threshold voltage
$V_{FB}$	-	flat band voltage
$V_d$	-	drift velocity
$W$	-	depletion layer width
$W_B$	-	base width of BJT
$W_p, W_N$	-	width of neutral p-region, n-region
$V_A$	-	BJT Early voltage
$V_{Br}$	-	breakdown voltage
$V_a$	-	applied voltage
$V_T$	-	thermal voltage (kT/q)
$V_{BrCBO}$	-	BJT breakdown voltage collector to base with emitter open
$V_{BrCEO}$	-	BJT breakdown voltage collector to emitter with base open
$x_n, x_p$	-	distance in the neutral n-region, p-region of a junction, measured from the edge of the depletion region
$X_n, X_p$	-	Penetration of the depletion region into the n-region, p-region measured from the metallurgical junction
$Z$	-	dimension in z-direction
$\alpha$	-	common base short circuit current gain
$\alpha$	-	optical absorption coefficient
$\alpha_r$	-	recombination coefficient
$\alpha_T$	-	transport factor
$\gamma$	-	emitter injection efficiency
$\Delta_{pC}, \Delta_{pE}$	-	excess hole concentration in the base of a BJT, evaluated at the edge of the depletion region of the collector, emitter junction
$\int, \int_r, \int_0$	-	permittivity, relative dielectric constant, permittivity of free space; $\int = \int_0^r$
$\lambda$	-	wave length of light
$\mu$	-	mobility
$\nu$	-	frequency of light
$\rho$	-	resistivity, charge density
$\sigma$	-	conductivity
$\tau_n, \tau_p$	-	lifetime of electrons holes
$\tau_i$	-	transit time
$\tau_B$	-	transit time in the base of BJT
$\phi$	-	flux density, potential
$\phi_F$	-	Fermi potential
$\phi_s$	-	surface potential

$\phi_m$	-	work function potential of metal
$\phi_{sc}$	-	work function potential of semiconductor
$\psi$	-	time independent wave function
$\chi_s$	-	electron affinity- of semiconductor
$\Psi$	-	time dependent wave function
$\eta$	-	ideality factor of p-n junction
$\delta_n, \delta_p$	-	excess electron, hole concentration
$\omega$	-	angular frequency
$\Delta_{pC}, \Delta_{pE}$	-	excess electron, hole concentration at the edge of depletion region on the p-side, n-side

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